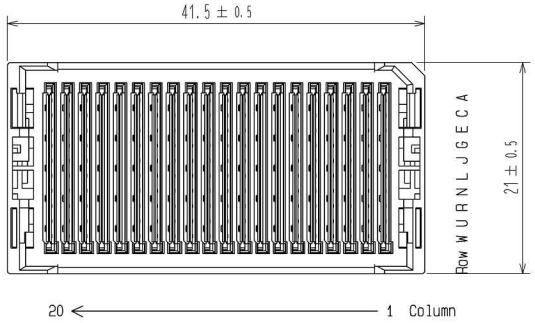


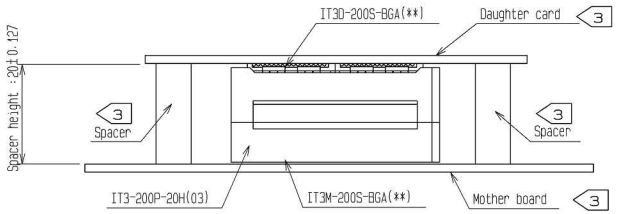
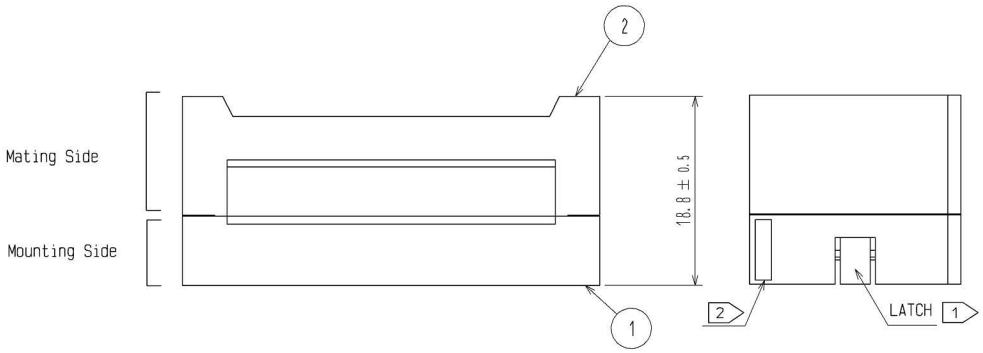
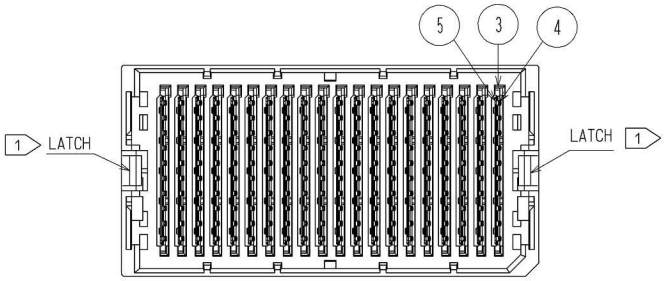
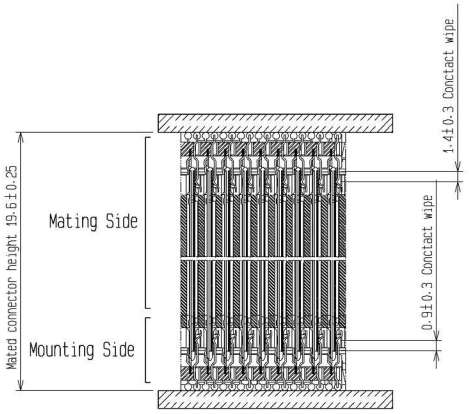




Fig.1(FREE)




Mating Cross Section (Free)

NOTE. 1 Mounting side is mated with the receptacle:IT3M-200S-BGA(**) and fixed with the latch.
2 Lot No. shall be marked on the indicated position.
3 The indicated mother board and daughter card shall be fastened to the additional reinforcements to prevent the stress on IT3*-200S-BGA(**) solder joints.
4. More information of this product is available in HIROSE document :ETAD-F0347 "IT3 design guideline".
5. This product consists of 200 signal lines and 180 ground lines.
6. 40pcs of this products are packed in a soft tray.
7. Standard package of 80pcs are packaged in a carton box.

| NO. | MATERIAL | FINISH, REMARKS | NO. | MATERIAL | FINISH, REMARKS |
|---|---|---|---|---|---|
| 3 | LCP | BLACK UL94V-0 | | | |
| 2 | PBT | GRAY UL94V-0 | 5 | Copper Alloy | CONTACT AREA:NICKEL(1.5μm)+GOLD (0.76μm) |
| 1 | PBT | BLACK UL94V-0 | 4 | Copper Alloy | CONTACT AREA:NICKEL(1.5μm)+GOLD (0.76μm) |

| UNITS | SCALE | COUNT | DESCRIPTION OF REVISIONS | DESIGNED | CHECKED | DATE |
|---|---|---|---|---|---|---|
| mm | 2 : 1 | | | | | |

HRS HIROSE ELECTRIC CO., LTD.

| | | | | |
|---|---|---|---|---|
| APPROVED | TM. MATSUO | 09. 09. 29 | DRAWING NO. | EDC3-326462-01 |
| CHECKED | MK. EZAKI | 09. 09. 29 | PART NO. | IT3-200P-20H(03) |
| DESIGNED | TS. SAITO | 09. 09. 26 | CODE NO. | CL636-0224-7-03 |
| DRAWN | TS. SAITO | 09. 09. 26 | | 1/1 |